## Effect of SiC on the Properties of Pressureless and Spark Plasma Sintered Si<sub>3</sub>N<sub>4</sub> Composites

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#### Abstract

 $Si_3N_4$ -SiC composites were prepared by adding SiC particles to the matrix in different weight ratios. The samples were sintered with two different methods. The samples were produced by pressureless sintering and spark plasma sintering method. In the first method, cold isostatic pressing method was used to press the composites. The samples were pressureless sintered at 1850  $^{\circ}$ C for 1 hour under the nitrogen atmosphere. In the second method, the samples were spark plasma sintered at 1650  $^{\circ}$ C under nitrogen atmosphere under 40 MPa for 5 minutes. AlN and Y<sub>2</sub>O<sub>3</sub> were also added to Si<sub>3</sub>N<sub>4</sub>-SiC composite mixture to aid sintering. Addition of SiC particles to the Si<sub>3</sub>N<sub>4</sub> matrix play critical role in controlling of densificication and microstructure properties of the sintered samples. The effect of composition and microstructure on properties of sintered samples was analyzed.

Keywords: Silicon nitride, silicon carbide, composite, microstructure

#### Basınçsız ve Spark Plazma Sinterlenmiş Si<sub>3</sub>N<sub>4</sub> Kompozitlerin Özelliklerine SiC'ün Etkisi

#### Öz

SiC partikülleri matriks içine farklı ağırlık oranlarında katılarak Si<sub>3</sub>N<sub>4</sub>-SiC kompozit hazırlanmıştır. Numuneler iki farklı yöntem ile sinterlenmiştir. Numunelere basınçsıs sinterleme ve spark plazma sinterleme yöntemleri uygulanmıştır. Birinci yöntemde, kompozitleri preslemede soğuk izostatik metodu kullanılmıştır. Numuneler 1850 <sup>0</sup>C'de azot atmosferi altında 1 saat basınçsız olarak sinterlenmiştir. İkinci yöntemde, numuneler azot atmosferi altında 1650 <sup>0</sup>C'de 5 dakika spark plazma ile sinterlenmiştir. AlN and Y<sub>2</sub>O<sub>3</sub> sinterlemeye yardımcı olması için katılmıştır. SiC partiküllerinin Si<sub>3</sub>N<sub>4</sub> matrisine eklenmesi, sinterlenmiş numunelerin yoğunluk ve mikroyapı özelliklerinin kontrol edilmesinde kritik rol oynar. Bileşim ve mikroyapının, sinterlenmiş numunelerin özelliklerine etkisi analiz edilmiştir.

Anahtar Kelimeler: Silisyum Nitrür, silisyum karbür, kompozit, mikroyapı

### 1. Introduction

Composite ceramics have better mechanical properties than monolithic ceramics.

 $Si_3N_4/SiC$  ceramics could be used in applications up to 1500  $^{0}C$  temperature, such as turbine and automobile engine component, also in energy applications because of its

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many good properties such as low thermal conductivity, thermal shock resistance, chemical stability and oxidation resistance (Ting et al.,2012; Jun et al.,2013; Jyothi et al.,2014; Hededusova et al.,2009; Yusen et al.,2018; Ravindra et al., 2015; Baloj et al.,2007; Jianfeng et al.,2007).

SiC particles disperse as a second phase in the matrix of Si<sub>3</sub>N<sub>4</sub> particles and / or in the grain boundary. However, in the production of hot pressing composites, process and pressureless sintering of Si<sub>3</sub>N<sub>4</sub> and SiC powder of fine particles can have sometimes problems and often does not produce the expected results (Lojanova et al.,2010). Different types of sintering additives are used in nonoxides ceramics, such as MgO, Al<sub>2</sub>O<sub>3</sub>,  $Y_2O_3$ , etc. Due to the high surface energy which causes the agglomeration of the SiC particles in the Si<sub>3</sub>N<sub>4</sub> matrix, gives rise to difficulties to obtain a homogeneous dispersion (Asit et al., 2006; Tatarko et al.,2013).

Generally, it is difficult to obtain highly dense Si<sub>3</sub>N<sub>4</sub> ceramics. In addition, high sintering temperature and the application of external

pressure are beneficial to their full densification. To date, pressure-assisted sintering method has been introduced to achieve silicon nitride ceramics with high density (Yao et al.,2018).

The aim of the present work is to prepare SiC reinforced silicon-nitride composites by pressureless and spark plasma sintering, and to study the sintering, density and microstructure of the resultant composites.

### 2. Material and Methods

The starting mixtures of Si<sub>3</sub>N<sub>4</sub>-SiC composites consisted the following of powders: Commercial α-Si<sub>3</sub>N<sub>4</sub> powder (UBE Industries, SN-E10), SiC powder (H.C Starck Grade UF-25) were used as powder precursors. Figure 1 shows XRD patterns of the starting powders. High purity AlN (H.C. Starck Grade C, Germany) and Y<sub>2</sub>O<sub>3</sub> (H.C. Starck Grade C, Germany) were used as additives for liquid-phase sintering to promote densifications given in the previous study (Taslicukur et al.,2012). Particle size distribution of Si<sub>3</sub>N<sub>4</sub> and SiC was given in Figure 2.



Figure 1. XRD spectrum of (a)  $\alpha$ - Si<sub>3</sub>N<sub>4</sub> powder (b) SiC powder





Figure 2. Particle size distribution of (a) Si<sub>3</sub>N<sub>4</sub> (b) SiC

Composition of composite powder mixtures was given in Table 1. Si<sub>3</sub>N<sub>4</sub>, SiC, AlN and Y<sub>2</sub>O<sub>3</sub> were mixed with ethanol for 5 h. 1 wt % binder polyvinyl alcohol (PVA) was added to ensure the strength before sintering process. The slurries were dried at 150  $^{0}$ C for 12 h, and then sieved to a particle size < 150 µm. In the pressureless sintered method, the mixture was

cold pressed under 1,5 tons and then cold isostatic pressed under 150 MPa for 4 min. The compacts were sintered at  $1850 \,^{0}$ C for 1 h under nitrogen atmosphere. In the spark plasma sintering method, the samples were spark plasma sintered at 1650  $\,^{0}$ C under nitrogen atmosphere under 40 MPa for 5 minutes.

| Sample | Si <sub>3</sub> N <sub>4</sub> | SiC   | AlN   | Y <sub>2</sub> O <sub>3</sub> |
|--------|--------------------------------|-------|-------|-------------------------------|
| (wt%)  | (wt%)                          | (wt%) | (wt%) | (wt%)                         |
| SiC10  | 80                             | 10    | 5     | 5                             |
| SiC20  | 70                             | 20    | 5     | 5                             |
| SiC30  | 60                             | 30    | 5     | 5                             |

Table 1. Composition of starting mixtures

Archimedes' immersion method was used to measure the densities of the samples. The crystal structure of the samples were investigated by X-ray diffractometry (XRD) analysis, X'Pert Pro MRD Panalytical diffractometer. Scanning electron microscopy(SEM) (JEOL JSM-7000 F) was used to characterize the microstructure of the samples. Hardness of the samples was tested on a micro Vicker(Struers Duramin A-300) with an applied load of 2 kg.

# 3. Research Findings

Relative density decreases due to the increase of SiC (by weight %) content in the composite as seen in Table 2. The composite which was reinforced with 10(wt%) SiC has the highest relative density 84.16% and the relative density of the sintered sample having 30 % by weight SiC decreases to % 79.31 in the pressureless sintered composite. It is difficult to sinter SiC because of its strong covalent bond structure with pressureless sintering. This behaviour could be attributed to the presence of SiC particles, which tend to inhibit shrinkage and densification during firing. As the Si<sub>3</sub>N<sub>4</sub> matrix shrinks, a rigid SiC particle generates a shear stress in the matrix and a tensile hoop stress at the particle-matrix interface. Until this shear stress can be relaxed by shear flow in the matrix or by viscous flow of the liquid phase, the hoop stress will act to inhibit sintering and to reduce densification, this effect being dependent on the volume of the SiC inclusions(Gunay et al., 1995). The composite which was reinforced with 10(wt%) SiC has the highest relative density 99.60 % and the relative density of the sintered sample having 30 % by weight SiC decreases to % 99.30 in the spark plasma sintered composite. Nearly the full density was achieved using spark plasma sintering technique.

**Table 2.** Relative density of samples pressureless sintered at 1850 °C for 1 hour and sparkplasma sintered at 1650 °C for 5 minutes

| Sample | Relative Density       | Relative Density                            |
|--------|------------------------|---|
| (wt%)  | (%)                    | (%)   |
|        | (pressureless-1850 °C) | (spark plasma sintered-1650 <sup>0</sup> C) |
| SiC10  | 84.16                  | 99.60                                       |
| SiC20  | 84.12                  | 98.70                                       |
| SiC30  | 79.31                  | 99.30                                       |

Si<sub>3</sub>N<sub>4</sub> presents two different morphologies in Si<sub>3</sub>N<sub>4</sub>-SiC materials. It was found that  $\alpha$ - $\beta$ transformation of the Si<sub>3</sub>N<sub>4</sub>/SiC composite occured during sintering. Taslicukur et al, sintered Si<sub>3</sub>N<sub>4</sub>-C composites to synthesize Si<sub>3</sub>N<sub>4</sub>-SiC composites by in-situ carbothermal reduction process at 1700 <sup>0</sup>C and 1850 <sup>0</sup>C in the previous study, indicated that the relative density of the samples increased due to the increase of the sintering temperature. The sintering temperature, 1850  $^{0}$ C, was determined according to the previous study(Taslicukur et al.,2012). Figure 3 also illustrated that  $\beta$ -Si<sub>3</sub>N<sub>4</sub> was the major phase in

all of the samples.  $\alpha$ -Si<sub>3</sub>N<sub>4</sub> and SiC peaks were also determined. When SiC (wt amount %) increases in the Si<sub>3</sub>N<sub>4</sub> matrix, the intensity of  $\beta$ -Si<sub>3</sub>N<sub>4</sub> phase decreases. X-rays results indicated that  $\alpha$ - $\beta$  transformation is not fully completed because of the short sintering time and / or the low sintering temperature. Taslicukur et al, spark plasma sintered Si<sub>3</sub>N<sub>4</sub>/SiC composite at 1650 <sup>o</sup>C under nitrogen atmosphere under 40 MPa for 5 minutes. Higher hardness values of the composites were determined due to the addition of harder SiC into the  $Si_3N_4$  matrix(Taslicukur et al.,2012). The composite with 10 wt% has the hardness of 21.4 GPa, while the composite with 30 wt% has the hardness of 22.5 GPa.







**(b)** 

Figure 3. XRD patterns of composite samples sintered at 1850  $^{0}$ C for 1 hour under nitrogen atmosphere (a) Si<sub>3</sub>N<sub>4</sub>-20 wt% SiC and (b) Si<sub>3</sub>N<sub>4</sub>-30 wt% SiC.

Figure 4 illustrates the SEM images of  $Si_3N_4/SiC$  ceramics composites sintered at 1850 °C for 1 h under nitrogen atmosphere. It is noticed that due to the increase of SiC in the  $Si_3N_4$  matrix, equiaxed grains formed instead of elongated grains. The SiC particles located around the  $\beta$ -Si<sub>3</sub>N<sub>4</sub> grains and prevented the



**(a)** 

densification of the Si<sub>3</sub>N<sub>4</sub> matrix(Rice,1998). SiC particles hindered the grain growth of silicon nitride by grain boundary pinning (Lojanova et al., 2010). As can be seen from Figure 4(c), it was found that the  $\beta$ -grains in the structure decreased and an equaxial structure was formed.







**(c)** 

Figure 4. SEM micrographs of the Si<sub>3</sub>N<sub>4</sub>-SiC composites sintered at 1850 <sup>o</sup>C for 1 h under nitrogen atmosphere (a) Si<sub>3</sub>N<sub>4</sub>-20 wt% SiC and (b) Si<sub>3</sub>N<sub>4</sub>-30 wt% SiC (c) spark plasma sintered at 1650 <sup>o</sup>C under 40 MPa for 5 min- Si<sub>3</sub>N<sub>4</sub>-10 wt% SiC

### 4. Results

Preparation of  $Si_3N_4/SiC$  composites with pressureless sintering and spark plasma sintering have been performed using AlN and  $Y_2O_3$  as sintering additives. The influence of SiC particle amount on the density and microstructure of  $Si_3N_4/SiC$  composites was investigated. According to XRD results, main phases are  $\alpha$ -Si<sub>3</sub>N<sub>4</sub>,  $\beta$ -Si<sub>3</sub>N<sub>4</sub> and SiC. SiC prevents the transformation of  $\alpha$ -Si<sub>3</sub>N<sub>4</sub> to  $\beta$ -Si<sub>3</sub>N<sub>4</sub> and it also inhibits the growth of  $\beta$ -Si<sub>3</sub>N<sub>4</sub> grains in the Si<sub>3</sub>N<sub>4</sub> matrix. Relative density decreased from %84.16 to %79.31, when the content of SiC(%wt) increased from %10 to %30. Si<sub>3</sub>N<sub>4</sub>/SiC composites were prepared via spark plasma sintering at  $1650 \,^{0}$ C under 40 MPa under nitrogen atmosphere in a very short time, 5 min, with nearly full density. The results indicate that the presence of SiC as a second phase lowered the densification. Higher hardness values of the composites were achieved due to the addition of SiC into the Si<sub>3</sub>N<sub>4</sub> matrix.

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